



Storrey's Docket No. 5649-1182

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In re: Kim et al. Examiner: George A. Goudreau
Serial No.: 10/772,319 Group Art Unit: 1763
Filed: November 24, 2003 Confirmation No. 9100
For: **METHODS FOR FRAMING A THIN FILM ON AN INTEGRATED CIRCUIT
INCLUDING SOFT BAKING A SILICON GLASS FILM**

January 25, 2005

**INFORMATION DISCLOSURE STATEMENT UNDER 37 C.F.R. § 1.97(c)
FOR APPLICATION FILED AFTER JUNE 30, 2003**

Attached is a list of documents on Form PTO-1449, together with a copy of any listed foreign patent document and/or non-patent literature. A copy of any listed U.S. patent and/or U.S. patent application publication is not provided herewith in accordance with the amendment by the U.S. Patent and Trademark Office to 37 C.F.R. § 1.98(a)(2)(ii) effective October 21, 2004. Also enclosed is a translation or a concise explanation of each non-English language document enclosed. It is requested that these documents be considered by the Examiner and officially made of record in accordance with the provisions of 37 C.F.R. § 1.56 and Section 609 of the MPEP.

This Information Disclosure Statement is submitted in accordance with 37 C.F.R. § 1.97(c), before final Office Action or Allowance, whichever is earlier.

In accordance with the requirements of 37 C.F.R. § 1.97(c)(1), the following Certification as specified in 37 C.F.R. § 1.97(e) is made:

Each item of information contained in this Statement was cited in a communication from a foreign patent office in a counterpart application not more than three (3) months prior to the filing of this statement.